

# 15 Inch HD LCD WDS750 BGA Reballing Machine High Automation With HD Camera

# Basic Information

- Place of Origin:
- Brand Name:
- Certification:
- Model Number:
- Minimum Order Quantity: 1
- Packaging Details: Wooden
- Delivery Time: 3-5 working of

CHINA

WDS

CE

- Payment Terms:
- Supply Ability:

WDS750
1 UNIT
Wooden case
3-5 working days
T/T, Western Union, MoneyGram
150 UNITS PER MONTH



# Product Specification

• Highlight:

High Automation BGA Reballing Machine, HD Camera BGA Reballing Machine, HD Camera Automatic Reballing Machine



### More Images



### WDS-750 Features:

1. Touch screen interface, heating time, heating temp, temp rise speed, cooling time, alarm advance, vacuum time are set up inside the touch screen, easy to use;

2.Panasonic PLC, independent control temperature control module, shows 3 temp curves all the time, 4 independent sensors, check the temp accurately for the chip points, ensure the weld yield;

3.3 independent heating zones, each heating zone can set up the heating temp, heating time, temp rise rate; Six period of heating temperature, simulate the reflow heating mode, set up as Preheating, keeping, heating, welding, welding, cooling;

4. Auto feed chip, auto pick up chip, auto blowing chip, can identify the central position automatically when optical alignment;

5.Multifunction mode choice, four modes as weld, remove, mount, manual, automatic and semi-auto function, meet the various needs of the users;

6.Uses the high precision K-type thermocouple closed-loop control which is imported from USA,with the unique heating method, ensure the weld temp precision control within  $\pm 1$  °C

7.Uses imported optical alignment system,500 pixel HD camera,HDMMI HD signal output,15 inch HD LCD,high accurate micrometer X/Y/Z axis adjustment,ensure the location precision within 0.01-0.02mm;

8. The upper heating head and placement head are designed 2 in 1, different size of heating nozzles are provided, easy to remove and install, can be customized, meet the more requirement for users;

9. High automation and precision to avoid artificial error fully,can make the best repairing effect for the lead free technology,double-deck BGA,QFN,QFP,capacitance resistance and other components and parts;

10.Equipped the extra camera to obverse the solder ball melting, to ensure the temp curve and weld effect(this function is optional).

#### WDS-750 parameter:

TEC FOC parameter	
Total power	6800W
Upper heating power	1200W
Bottom heating power	1200W
Bottom IR heating power	4200W(2400W is controlled)
Power supply	(Single Phase) AC 220V±10 50Hz
Location way	Optical camera+ V-shape card slot + laser position for fast location
Temperature control	High precision K sensor closed loop control,independent temperature control with ±1 °C precision
Appliance selection	High sensitive touch screen + temperature control mode +Panasonic PLC +step driver
Max. PCB size	550×480mm
Min. PCB size	10×10mm
Sensor	4units
Chip amplification multiple	1-200X
PCB thickness	0.5-8mm
Chip size	0.2*0.4mm-9cm
Min. chip space	0.15mm
Max. mount loading	100G
Mount precision	±0.01mm
Overall size	L670×W770×H900mm
Optical camera	Can be removed front and back,left and right,prevent the dead angle
Machine weight	90kg



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